

Electronic Acknowledgement Receipt

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Application Number:	10597136
Confirmation Number:	6533
Title of Invention:	SEMICONDUCTOR DEVICE MODULE STRUCTURE
First Named Inventor:	Kenji Kitamura
Customer Number:	40854
Filer:	David Spaw
Filer Authorized By:	
Attorney Docket Number:	SHM-16693
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Application Data Sheet	16693-ApplDataSheet.pdf	4153506	no	6
Warnings:					
Information:					
2	Transmittal letter	16693-TransmittalLtr.PDF	67239	no	1
Warnings:					
Information:					
3	Oath or Declaration filed	16693-Declaration.PDF	94333	no	2
Warnings:					
Information:					
4		16693-Specification.PDF	949137	yes	21
	Multipart Description				
	Doc Desc		Start	End	
	Specification		1	19	
	Claims		20	20	
	Abstract		21	21	
Warnings:					
Information:					
5	Drawings	16693-Drawings.PDF	232726	no	6
Warnings:					
Information:					
6	Documents submitted with 371 Applications	16693-SearchReport.PDF	113731	no	2
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Information:					
7	Information Disclosure Statement (IDS) Filed	16693-IDS.pdf	865291	no	4
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8	Foreign Reference	16693-Ref1.PDF	829793	no	11
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9	Foreign Reference	16693-Ref2.PDF	876154	no	11
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10	Foreign Reference	16693-Ref3.PDF	555182	no	8
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11	Fee Worksheet (PTO-875)	fee-info.pdf	8370	no	2
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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

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